

SCHWEGMAN ■ LUNDBERG ■ WOESSNER ■ KLUTH
PATENT, TRADEMARK & COPYRIGHT ATTORNEYS
P.O. Box 2938
Minneapolis, MN 55402
Telephone (612) 373-6900 Facsimile (612) 339-3061

Fax Transmission

To: Examiner Caridad Everhart (Art Unit 2825)
Company: U. S. Patent and Trademark Office
Fax #: 703-746-4107

From: Viet Tong
Date: August 7, 2003
Re: US Serial No. 09/945536
SLWK #303.469US3

You should receive 10 page(s) including this one.
If you do not receive all pages, please call (612) 373-6969

US Serial No. 09/945536
SLWK #303.469US3

Title: THERMAL PROCESSING OF METAL ALLOYS FOR AN IMPROVED CMP PROCESS IN
INTEGRATED CIRCUIT FABRICATION

Dear Examiner Everhart:

Thank you for discussing the pending claims with me today. Please feel free to do an Examiner Amendment to expedite the prosecution of the above-identified patent application.

Please contact me (612-379-6969), if you have any questions.

Sincerely,

Viet Tong

(612) 373-6969

*Proposed,
Unofficial Copy*
*Do Not
enter*

This transmission contains information that is confidential and/or legally privileged. It is intended for use only by the person to whom it is directed. If you have received this facsimile in error, please notify us by telephone immediately so that we can arrange for the return of the original documents to us. If you do NOT receive all of the pages, please telephone us in the U.S.A. at (612) 373-6900 or FAX us at (612) 339-3061.

S/N 09/945536**PATENT****IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

| | | | |
|-------------|---|-----------------|------------|
| Applicant: | Paul A. Farrar et al. | Examiner: | C Everhart |
| Serial No.: | 09/945536 | Group Art Unit: | 2825 |
| Filed: | August 30, 2001 | Docket No.: | 303.469US3 |
| Title: | THERMAL PROCESSING OF METAL ALLOYS FOR AN IMPROVED CMP PROCESS IN INTEGRATED CIRCUIT FABRICATION | | |

SUPPLEMENTAL AMENDMENT

Commissioner for Patents
P.O.Box 1450
Alexandria, VA 22313-1450

Applicant discussed the pending claims with the Examiner on telephone on August 7, 2003. To expedite the prosecution, please amend the above-identified patent application as follows.